

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**AMENDMENT "A" AND
SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

APPLICANT: Marcel Heerman
SERIAL NO.: 09/997,345 GROUP ART UNIT: 2811
DATE FILED: November 29, 2001
INVENTION: "AN INTERMEDIATE BASE FOR A SEMICONDUCTOR
MODULE, A SEMICONDUCTOR MODULE USING
THE INTERMEDIATE BASE AND A METHOD FOR
PRODUCING THE INTERMEDIATE BASE"

Assistant Commissioner for Patents
Washington, D.C. 20231

S I R:

Prior to examination, please amend the above-identified application as follows:

IN THE SPECIFICATION:

On page 5, please amend the paragraph starting at line 1 to read as follows:


A/ --A film composed of LCP (Liquid Crystal Polymer) or a material with similar
thermal expansion characteristics is highly suitable for use as a material for the intermediate base.
This material is described, for example, in an article in Advancing Microelectronics, July/August
1998, pages 15-18.--

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231 on January 15, 2002.

James D. Hobart

Name of Applicant's Attorney



Signature

January 15, 2002

Date

RECEIVED
FEB 14 2002
TC 2800 MAIL ROOM